

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr><td>Tomohiro KOBAYASHI</td><td>10/19/2011</td></tr> <tr><td>Eiji FUKUDA</td><td>10/19/2011</td></tr> <tr><td>Takayuki NAGASAWA</td><td>10/19/2011</td></tr> <tr><td>Ryosuke TANIGUCHI</td><td>10/19/2011</td></tr> <tr><td>Youichi OHSAWA</td><td>10/19/2011</td></tr> <tr><td>Masayoshi SAGEHASHI</td><td>10/19/2011</td></tr> <tr><td>Yoshio KAWAI</td><td>10/19/2011</td></tr> </tbody> </table>		Name	Execution Date	Tomohiro KOBAYASHI	10/19/2011	Eiji FUKUDA	10/19/2011	Takayuki NAGASAWA	10/19/2011	Ryosuke TANIGUCHI	10/19/2011	Youichi OHSAWA	10/19/2011	Masayoshi SAGEHASHI	10/19/2011	Yoshio KAWAI	10/19/2011
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr><td style="width: 20%;">Name:</td><td>Shin-Etsu Chemical Co., Ltd.</td></tr> <tr><td>Street Address:</td><td>6-1, Ohtemachi 2-chome, Chiyoda-ku,</td></tr> <tr><td>City:</td><td>Tokyo</td></tr> <tr><td>State/Country:</td><td>JAPAN</td></tr> </table>		Name:	Shin-Etsu Chemical Co., Ltd.	Street Address:	6-1, Ohtemachi 2-chome, Chiyoda-ku,	City:	Tokyo	State/Country:	JAPAN								
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CORRESPONDENCE DATA																	
<p>Fax Number: (703)205-8050</p> <p>Phone: 7032058000</p> <p>Email: mailroom@bskb.com, mussie.beyene@bskb.com</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: BIRCH, STEWART, KOLASCH, & BIRCH, LLP.</p> <p>Address Line 1: P.O. BOX 747</p> <p>Address Line 4: Falls Church, VIRGINIA 22040-0747</p>																	
ATTORNEY DOCKET NUMBER:	0171-1641PUS1																

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PATENT
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NAME OF SUBMITTER:

Gerald M. Murphy, Jr.

Total Attachments: 3

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BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No. 13/303,302 Filed November 23, 2011

Insert Name(s)
of Inventor(s) ***** (Given Name FAMILY NAME (ALL CAPS)) *****

WHEREAS, Tomohiro KOBAYASHI, Eiji FUKUDA, Takayuki NAGASAWA, Ryosuke TANIGUCHI, Youichi OHSAWA, Masayoshi SAGEHASHI and Yoshio KAWAI of Joetsu-shi, Niigata-ken, Japan (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in:

Insert Title
of Invention **Positive Resist Composition and Patterning Process**

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application)

Insert Date
of Signing of
Application on October 19, 2011; and

Insert Name
of Assignee WHEREAS, Shin-Etsu Chemical Co., Ltd.

Insert Address
of Assignee of 6-1, Ohtemachi 2-chome, Chiyoda-ku, Tokyo, Japan

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

CHECK BOX
IF APPROPRIATE ☐ in any foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date October 19, 2011,

Name of Inventor

Tomohiro Kobayashi
(signature) Tomohiro KOBAYASHI

Date October 19, 2011,

Name of Inventor

Eiji Fukuda
(signature) Eiji FUKUDA

Date October 19, 2011,

Name of Inventor

Takayuki Nagasawa
(signature) Takayuki NAGASAWA

Date October 19, 2011,

Name of Inventor

Ryosuke Taniguchi
(signature) Ryosuke TANIGUCHI

Date October 19, 2011,

Name of Inventor

Youichi Ohsawa
(signature) Youichi OHSAWA

Date October 19, 2011,

Name of Inventor Masayoshi Sagehashi
(signature) Masayoshi SAGEHASHI

Date October 19, 2011,

Name of Inventor Yoshio Kawai
(signature) Yoshio KAWAI